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Broadband MMIC LNAs for ALMA Band 2+3 With Noise Temperature Below 28 K

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Abstract—Recent advancements in transistor technology, such as the 35 nm InP HEMT, allow for the development of monolithic microwave integrated circuit (MMIC) low noise amplifiers (LNAs) with performance properties that challenge the hegemony of SIS mixers as leading radio astronomy detectors at frequencies as high as 116 GHz. In particular, for the Atacama Large Millimeter and Submillimeter Array (ALMA), this technical advancement allows the combination of two previously defined bands, 2 (67–90 GHz) and 3 (84–116 GHz), into a single ultra-broadband 2+3 (67–116 GHz) receiver. With this purpose, we present the design, implementation, and characterization of LNAs suitable for operation in this new ALMA band 2+3, and also a different set of LNAs for ALMA band 2. The best LNAs reported here show a noise temperature less than 250 K from 72 to 104 GHz at room temperature, and less than 28 K from 70 to 110 GHz at cryogenic ambient temperature of 20 K. To the best knowledge of the authors, this is the lowest wideband noise ever published in the 70–110 GHz frequency range, typically designated as W-band.

Index Terms—Atacama Large Millimeter and Submillimeter Array (ALMA), band 2+3, broadband, cryogenic, low noise amplifier (LNA), monolithic microwave integrated circuit (MMIC), 35 nm InP, W-band, WR-10.

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This paper demonstrates the first LNAs suitable for operation in the 67–116 GHz frequency range with a noise temperature lower than the receiver specification shown in Table I. Moreover, the LNAs presented here are also suitable for future radio astronomy projects with broadband receivers in the W-band frequency range, such as the ngVLA [2] or LLAMA [3], and other non-astronomical applications such as automotive radars or millimeter wave imagers, which are of increasing demand in modern society [4].

II. MMIC DESIGNS

This section presents two MMIC designs, one for band 2 and the other for band 2+3, which were developed using the state-of-the-art 35 nm gate length InP HEMT process of NGC [5]. This technology features a cutoff frequency greater than 400 GHz and a maximum transconductance (gm)
greater than 2200 mS/mm at a drain–source voltage \( V_D \) of 1 V. The LNA chips were fabricated onto a 50 \( \mu \)m thick InP substrate with through-substrate vias for grounding, 20 and 100 \( \Omega / \text{sq} \) thin-film resistors, and 0.3 nF/mm\(^2\) metal-insulator-metal capacitors. The transistors were passivated with a thin silicon nitride layer. Both MMIC designs consist of two transistor stages in common-source topology with the possibility of independent drain and gate biasing, and utilize 2-finger transistors whose total size (number of fingers × finger width) is 60 \( \mu \)m per stage. The MMIC design process was performed with individual simulation of the different matching networks using the electromagnetic (EM) simulator momentum, a tool included with the Keysight ADS package [6].

Figs. 1 and 2 show a simplified schematic of the MMICs, a microscopic photograph of the fabricated devices, and their simulated cryogenic performance, for the band 2 and 2+3 designs, respectively. The size of the fabricated chips was 1300 × 900 \( \mu \)m for both design types.

### III. MMICs Characterization

The fabricated wafers contained 13 MMICs of each design. Packaging and testing LNAs is a costly and time-consuming process, and for these reasons, the MMICs could not be picked blindly for packaging [7]. In order to select and package only the best chips, they were first tested in the cryogenic probe station at Caltech’s Cahill Radio Astronomy Laboratory (CRAL), which was configured to perform noise measurements in the 74–116 GHz frequency range at an ambient temperature of 20 K, as detailed in [8]. Utilization of this instrument allowed us to perform a relative comparison of the different fabricated MMICs, and determine which ones had the best noise performance. It must be emphasized that the tests performed with this instrument did not provide absolute noise temperature measurements because the contribution of the lossy input probe was not calibrated, resulting in a systematic overestimate of the absolute noise temperature.

Cryogenic probing tests were performed for 10 MMICs of each design type, with the transistors biased at a current density (drain current divided gate width) of 67 mA/mm. Fig. 3 shows a microscopic photograph of the process for probing a band 2 MMIC. The results of the tests are shown in Figs. 4 and 5 for band 2 and 2+3 MMICs, respectively.

The yield of the band 2 and 2+3 MMIC designs can be estimated as 60% and 70%, respectively, at cryogenic temperature, based on the number of chips that did / did not turn on during the tests: 6/4 in the case of the band 2 design, and 7/3 in the case of the band 2+3 one. This is a result of both the fabrication process and the design parameters.

![Fig. 1. MMIC design for ALMA band 2 (67 to 90 GHz).](image)

(a) Simplified schematic. (b) Microscopic photograph of a fabricated MMIC. (c) Simulated S-parameters at 20 K ambient temperature (simulated S12 is better than 34 dB from 67 to 90 GHz). (d) Simulated noise at 20 K ambient temperature plotted against ALMA specifications for receiver noise.

### IV. LNAs Assembly

The best MMICs were selected and packaged in WR-10 blocks similar to that shown in Fig. 6, which were specifically
Fig. 2. MMIC design for ALMA band 2+3 (67 to 116 GHz). (a) Simplified schematic. (b) Microscopic photograph of a fabricated MMIC. (c) Simulated S-parameters at 20 K ambient temperature (simulated S12 is better than 30 dB from 67 to 116 GHz). (d) Simulated noise at 20 K ambient temperature plotted against ALMA specifications for receiver noise.

designed to cover the frequency range from 67 to 116 GHz. The WR-10 blocks were made of brass and gold plated with 5 μm gold over 5 μm nickel. Manufacture was in the mechanical workshops of the University of Manchester and the Rutherford Appleton Laboratory (RAL). The package was 3-D modeled with Autodesk Inventor [9], and EM simulated with Ansoft HFSS [10]. Table II gives the relationship of the MMICs packaged in each WR-10 block.

In order to couple the EM fields propagating along the waveguide channels to the microstrip lines at the input...
TABLE II
PACKAGING OF THE MMICs IN WR-10 BLOCKS

<table>
<thead>
<tr>
<th>WR-10 LNA reference</th>
<th>Chip reference</th>
<th>Design for ALMA band</th>
</tr>
</thead>
<tbody>
<tr>
<td>B2a</td>
<td>MMIC 6</td>
<td>2</td>
</tr>
<tr>
<td>B2b</td>
<td>MMIC 2</td>
<td>2</td>
</tr>
<tr>
<td>B23a</td>
<td>MMIC 9</td>
<td>2+3</td>
</tr>
<tr>
<td>B23b</td>
<td>MMIC 8</td>
<td>2+3</td>
</tr>
<tr>
<td>B23c</td>
<td>MMIC 11</td>
<td>2+3</td>
</tr>
<tr>
<td>B23d</td>
<td>MMIC 13</td>
<td>2+3</td>
</tr>
<tr>
<td>B23e</td>
<td>MMIC 7</td>
<td>2+3</td>
</tr>
</tbody>
</table>

and output of the MMICs, some E-plane waveguide-to-microstrip probes were specifically designed to operate in the 67–116 GHz frequency range, and manufactured. The fabricated probes can be seen in Fig. 7, which shows a photograph of one of the LNA blocks with the cover removed. Fig. 8 shows the simulated reflection coefficient of the probes from the MMIC side plotted against the simulated optimum reflection coefficient (Γopt) of the MMICs. The design of the probes was done with the EM simulator Ansoft HFSS, and fabrication material was 3 mil thick quartz substrate with 3 μm gold on both sides. Quartz is regarded as a suitable material for this application due to its low dielectric constant (εr) of 3.8.

Fig. 8. Smith chart plots of simulated: input reflection coefficient of the waveguide-to-microstrip probes from the MMIC side in the 67–116 GHz range (black line with rectangles), Γopt of the band 2 MMIC design (blue line with circles) in the 67–90 GHz range, and Γopt of the band 2+3 MMIC design (red line with triangles) in the 67–116 GHz range.

In addition, it is transparent and so allows for an easy alignment of the probes and removal of the excess epoxy in the waveguide channel.

Biasing of the transistors in the MMIC was done through a 9-pin micro-D connector embedded in the WR-10 blocks. LNAs are devices that operate at low voltages and are susceptible to damage from electrostatic discharge and improper biasing, as well as being sensitive to low-level interference [11]. For this reason, a protection circuit was included in the form of a PCB and some bondable decoupling capacitors close to the MMIC. The schematic of this circuit is shown in Fig. 9.

V. LNAs Characterization

The LNAs were characterized at room temperature for S-parameters and noise, and at cryogenic ambient temperature of 20 K for noise. Tests were done at the CRAL. The S-parameters were tested with a Rohde and Schwarz ZVA 24 Vector Network Analyzer, and ZVA-Z110 WR-10 converter head extensions. Noise characterization of the LNAs was performed by application of the Y-factor method, according to the
Fig. 10. Test setup for noise characterization at room temperature (295 K) and cryogenic temperature (20 K). DUT is the device (LNA) under test. X2 and X4 multipliers were turned ON/OFF with a LabVIEW vi interface, and only one was active at a time. The subharmonic mixer is the part WR10SHM from Virginia diodes.

Fig. 11. Interior of the Dewar with setup for characterizing two LNA blocks. test bench diagram shown in Fig. 10, and applying a correction to subtract the noise contribution of the back-end. For the room temperature measurements, the DUT LNA was attached to a rectangular horn, and the Y-factor method was applied with external 290 K “hot” and 77 K “cold” loads. For the noise characterization of the LNAs at cryogenic temperature, the DUT and the back-end LNA were inserted into a 20 K closed cycle cryostat, whose interior is shown in Fig. 11. In this case, the input of the DUT was attached to a variable temperature vane, configured to present “hot” and “cold” loads of 75 K and 25 K, respectively, at the input of the LNA. The results from these tests are presented in Fig. 12 for the ALMA band 2 LNAs and in Fig. 13 for the ALMA band 2+3 LNAs. The estimated random uncertainty of the cryogenic noise measurements is ±1.6 K (σ), based on the scatter of the IF power measurements and the uncertainty of the temperature sensor in the vane. This is consistent with the peak-to-peak scatter of ±1.9 K across the 75–105 GHz band for B23a (the device with the most uniform performance across this band). In addition, we estimate a potential systematic offset of up to ±2.7 K based on the accuracy of the power sensor and the power/temperature loss in the waveguide section between the vane and the DUT.

Fig. 12. Characterization of two WR-10 LNA blocks for ALMA band 2. Blocks are designated as B2a and B2b. Transistors were biased with a current density of 167 mA/mm for the room temperature measurements and 75 mA/mm for the cryogenic measurements. (a) Measured S-parameters at ambient temperature of 295 K. (b) Measured noise temperature at ambient temperature of 295 K. (c) Measured noise temperature at ambient temperature of 20 K plotted against specifications for ALMA receiver noise and simulated noise assuming 0.3 dB package loss prior to the MMIC.

It was experimentally determined that the best performance was obtained biasing the band 2 LNAs with a current density of 167 mA/mm at room temperature and 75 mA/mm at cryogenic temperature, and the band 2+3 LNAs with a current density of 200 mA/mm at room temperature and 67 mA/mm
VI. DISCUSSION OF RESULTS

In the previous section, the results of the LNA characterization were presented. From Fig. 12, it can be observed that the LNAs for ALMA band 2 (B2a and B2b) have very similar performance up to 82 GHz. However, the noise performance of B2b is superior in the 82–90 GHz range. As previously described, these LNAs for ALMA band 2 were designed to operate from 67 to 90 GHz. In this band, B2b has a room temperature gain of $16.5 \pm 1.5$ dB, and noise temperature between 225 and 430 K at room temperature and between 23 and 50 K at a cryogenic temperature of 20 K. Moreover, it is interesting to point out that B2b also has good performance from 90 to 100 GHz, featuring a cryogenic noise temperature of less than 30 K.

Concerning the LNAs for ALMA band 2+3, Fig. 13 shows that B23d and B23e achieve a noise temperature less than 250 K from 72 to 104 GHz at room temperature, and B23a and B23e show a cryogenic noise temperature less than 28 K from 70 to 110 GHz. We believe these results show the lowest broadband noise temperature so far reported for LNAs operating at W-band, and this is supported by a comparison with other state-of-the-art works from the literature in Table III.

Table IV is also provided to compare the noise performance of the LNAs with the specifications for receiver noise in five frequency bands of interest for ALMA. As described in Section I, these specifications are for maximum noise over 80% of the RF bandwidth, and maximum noise at any RF frequency. The frequency bands of study include the previously described bands 2, 3, and 2+3, and two alternative ones that we propose and designate as “extended band 2” (68 to 100 GHz) and “reduced band 2+3” (68 to 114 GHz). The noise specifications for these two alternative bands are not an official ALMA specification, and were calculated as a pro-rated average between the specifications for bands 2 and 3, as

$$\text{Spec}(K) = \frac{\text{BW}_{B2}(GHz) \cdot \text{Spec}_{B2}(K)}{\text{BW}_{TOTAL}(GHz)} + \frac{\text{BW}_{B3}(GHz) \cdot \text{Spec}_{B3}(K)}{\text{BW}_{TOTAL}(GHz)}$$

where BW and Spec are the bandwidth and noise specification of the corresponding frequency band.

It can be observed that although the band 2 LNAs have a noise performance comparable to other state-of-the-art devices in the same frequency range, they do not fully meet the ALMA specifications. This is due to their noise performance in the lower end of the band, from 67 to 73 GHz, which is higher than expected from the simulations.

We demonstrate on the other hand that the ALMA band 2+3 design presents a noise temperature lower than the ALMA receiver specifications for band 2, and significantly exceeds the specifications for band 3. This is best exemplified through the LNAs B23a, B23b, and B23e, which have a noise temperature less than 31 K over 80% of the bandwidth from 67 to 116 GHz, and less than 54 K at any RF frequency in the same range. The performance of these band 2+3 LNAs proves that it is possible to develop ultra-low noise W-band amplifiers with a relative bandwidth as high as 54%, and opens the door to a new generation of ultra-wideband radio astronomy receivers.

Fig. 13. Characterization of five WR-10 blocks for ALMA band 2+3. Blocks are designated as B23a, B23b, B23c, B23d, and B23e. Transistors were biased with a current density of 200 mA/mm for the room temperature measurements and 67 mA/mm for the cryogenic measurements. (a) Measured S-parameters at ambient temperature of 295 K. (b) Measured noise temperature at ambient temperature of 295 K. (c) Measured noise temperature at ambient temperature of 20 K plotted against ALMA specifications for receiver noise and simulated noise assuming 0.3 dB package loss prior to the MMIC. Samples with no color filling below 70 GHz were measured with a WR12 mixer (WR12SHM) instead of a WR10 one as described in Fig. 10. We believe the spike at 109 GHz in the cryogenic noise temperature of B23e may be due to an error in the measurement system.

at cryogenic temperature. With these biasing conditions the power consumption at cryogenic temperature is 10 mW in the case of the band 2 LNAs, and 6 mW in the case of the band 2+3 LNAs.
TABLE III
COMPARISON WITH STATE-OF-THE-ART LNAs FROM THE LITERATURE

<table>
<thead>
<tr>
<th></th>
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<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>70 – 100</td>
<td>15.5 ± 3</td>
<td>225 – 430</td>
<td>23 – 50</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>This work (B2b)</td>
</tr>
<tr>
<td>67 – 114</td>
<td>13 ± 3</td>
<td>246 – 438</td>
<td>22 – 28</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>This work (B23a)</td>
</tr>
<tr>
<td>68 – 113</td>
<td>14 ± 2</td>
<td>227 – 385</td>
<td>25 – 35</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>This work (B23b)</td>
</tr>
<tr>
<td>68 – 113</td>
<td>14.5 ± 2.5</td>
<td>227 – 385</td>
<td>22 – 40</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>This work (B23c)</td>
</tr>
<tr>
<td>75 – 110</td>
<td>15 ± 4</td>
<td>nr (1)</td>
<td>25 – 35</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>[14]</td>
</tr>
<tr>
<td>75 – 110</td>
<td>27 ± 2</td>
<td>nr (1)</td>
<td>24 – 40</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>[14]</td>
</tr>
<tr>
<td>75 – 116</td>
<td>21.5 ± 3.5</td>
<td>240 – 320</td>
<td>26 – 48</td>
<td>35 nm InP pHEMT</td>
<td>MMIC</td>
<td>[16]</td>
</tr>
<tr>
<td>70 – 110</td>
<td>23 ± 3</td>
<td>250 – 350</td>
<td>nr (1)</td>
<td>70 nm GaAs mHEMT</td>
<td>MMIC</td>
<td>[17]</td>
</tr>
<tr>
<td>80 – 100</td>
<td>18.5 ± 3</td>
<td>225 – 295</td>
<td>nr (1)</td>
<td>70 nm GaAs mHEMT</td>
<td>MMIC</td>
<td>[18]</td>
</tr>
<tr>
<td>75 – 110</td>
<td>18.5 ± 2.5</td>
<td>180 – 262</td>
<td>nr (1)</td>
<td>50 nm GaAs mHEMT</td>
<td>MMIC</td>
<td>[19]</td>
</tr>
<tr>
<td>60 – 90</td>
<td>22 ± 2</td>
<td>159 – 225</td>
<td>nr (1)</td>
<td>50 nm GaAs mHEMT</td>
<td>MMIC</td>
<td>[20]</td>
</tr>
<tr>
<td>60 – 80</td>
<td>16 ± 2</td>
<td>200 – 300</td>
<td>45 – 90</td>
<td>100 nm InP HEMT</td>
<td>MIC</td>
<td>[21]</td>
</tr>
</tbody>
</table>

(1) nr = not reported.
(2) Not tested from 67 GHz to 70 GHz.
(3) MMIC measurements only.

TABLE IV
CRYOGENIC NOISE PERFORMANCE OF THE LNAs VERSUS ALMA SPECIFICATIONS

<table>
<thead>
<tr>
<th>ALMA band</th>
<th>Band 2 LNAs</th>
<th>Band 2+3 LNAs</th>
<th>ALMA receiver specification (K)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>B2a (1)</td>
<td>B2b (1)</td>
<td>B23a (1)</td>
</tr>
<tr>
<td>Max noise over 80% bandwidth (K)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Band 2 (67-90 GHz)</td>
<td>32</td>
<td>36</td>
<td>26</td>
</tr>
<tr>
<td>Ext. Band 2 (68-100 GHz)</td>
<td>38</td>
<td>30</td>
<td>27</td>
</tr>
<tr>
<td>Band 3 (84-116 GHz)</td>
<td>-</td>
<td>-</td>
<td>28</td>
</tr>
<tr>
<td>Red. Band 2+3 (68-114 GHz)</td>
<td>-</td>
<td>-</td>
<td>27</td>
</tr>
<tr>
<td>Band 2+3 (67-116 GHz)</td>
<td>-</td>
<td>-</td>
<td>27</td>
</tr>
<tr>
<td>Maximum noise at any RF frequency (K)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Band 2 (67-90 GHz)</td>
<td>40</td>
<td>50</td>
<td>27</td>
</tr>
<tr>
<td>Ext. Band 2 (68-100 GHz)</td>
<td>43</td>
<td>50</td>
<td>28</td>
</tr>
<tr>
<td>Band 3 (84-116 GHz)</td>
<td>-</td>
<td>-</td>
<td>43</td>
</tr>
<tr>
<td>Red. Band 2+3 (68-114 GHz)</td>
<td>-</td>
<td>-</td>
<td>28</td>
</tr>
<tr>
<td>Band 2+3 (84-116 GHz)</td>
<td>-</td>
<td>-</td>
<td>43</td>
</tr>
</tbody>
</table>

Font color indicates if the noise of the LNA is below the receivers’ specification. Green: yes. Orange: no by less than 10%. Red: no by more than 10%.
(1) Not tested from 67 GHz to 70 GHz.
(2) Specification for receiver noise in extended band 2, reduced band 2+3, and band 2+3 calculated as the prorated average between bands 2 and 2+3 in the frequency range of interest: Noise (K) = (BW2/ BW TOTAL) * Spec2 + (BW2/ BW TOTAL) * Spec2+3. This is not an official ALMA specification, and it’s subject to the authors’ interpretation.

This provides considerable benefit to future radio astronomy where wide-bandwidth observations will be required [22].

VII. CONCLUSION

In this paper, we presented the design and implementation of two cryogenic LNA designs suitable for operation in the frequency ranges of ALMA band 2 (67 to 90 GHz), and a new combined band 2+3 (67 to 116 GHz). We showed the characterization results of two fully assembled WR-10 LNAs for band 2 and five for band 2+3. Some of these LNAs showed a noise temperature less than 250 K from 72 to 104 GHz at room temperature, and less than 28 K across all of W-band (70 to 110 GHz) at cryogenic ambient temperature of 20 K. After performing a comparison with other state-of-the-art works from the literature, we demonstrated that these LNAs establish a new record for broadband noise in W-band.

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The authors would like to thank the contributions of A. Galtress (Jodrell Bank) to the design of the WR-10 bodies and A. Baiza (JPL) to the assembly of the LNAs. They would also like to thank Prof. B. Ellison (RAL), Dr. R. Gawande (JPL), Dr. W. McGenn (University of Manchester), and Dr. S. Rea (RAL) for helpful discussions.
REFERENCES


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[24] In 2011, he joined Yebes Observatory, Yebes, Spain, where he was involved in the development of RF instrumentation for the 40 and 13 m telescopes. From 2012 to 2013, he was an RF Engineer at the private sector in Spain. His Ph.D. project consists of the development of MMIC LNAs for ALMA band 2+3 and other radio astronomy projects. From 2015 to 2016, he was a Visiting Ph.D. Researcher for six months with the California Institute of Technology, Pasadena, CA, USA, and NASA’s Jet Propulsion Laboratory, Pasadena.

[24] Danielle George (M’04) is currently a Professor of RF and microwave communication engineering with The University of Manchester, Manchester, U.K., where she is the Vice Dean for teaching and learning with the Faculty of Science and Engineering. She is involved in solving one of the 14 world engineering grand challenges of the 21st Century. She engineers tools for scientific discovery. Her current research interests include the design of low-noise amplifiers and communication systems for space and aerospace sectors.

[25] Gary A. Fuller received the Ph.D. degree from the Astronomy Department, University of California, Berkeley, CA, USA.

[26] He was a Pre-Doctoral Fellow with the Harvard-Smithsonian Center for Astrophysics (CfA), Cambridge, MA, USA. He was a Smithsonian Post-Doctoral Fellow with CfA and a Jansky Fellow with the National Radio Astronomy Observatory, Tucson, AZ, USA, and National Radio Astronomy Observatory, Charlottesville, VA, USA. He is currently a Professor of astrophysics with the Jodrell Bank Centre for Astrophysics (JBCA), School of Physics and Astronomy, The University of Manchester, Manchester, U.K., and he is a Principal Investigator and a Lead Scientist of the UK ALMA Regional Centre Node, JBCA. His current research interests include understanding the formation and early evolution of stars in our galaxy and other galaxies.

[27] Kieran Cleary received the M.Eng.Sc. degree in electronic engineering from the National University of Ireland, Dublin, Ireland, in 1994, and the Ph.D. degree in radio astronomy (on cosmic microwave background observations using the Very Small Array) from The University of Manchester, Manchester, U.K., in 2004. From 2004 to 2006, he was a Post-Doctoral Scholar with the Jet Propulsion Laboratory, California Institute of Technology, Pasadena, CA, USA, where he was involved in the properties of powerful radio galaxies using the Spitzer Space Telescope. Since 2006, he has been with the California Institute of Technology, where he is currently a Senior Staff Scientist, involved in an experiment to measure redshifted carbon monoxide emission from the epoch of galaxy assembly, as well as leading the Cahill Radio Astronomy Laboratory.

[28] Lorene Samoska (M’95–SM’04) received the B.S. degree in engineering physics from the University of Illinois, Urbana-Champaign, IL, USA, in 1989, and the Ph.D. degree in materials engineering from the University of California (UC), Santa Barbara, CA, USA, in 1995.

[29] She was a Post-Doctoral Researcher with UC, where she was involved in the design and fabrication of state-of-the-art InP HBT microwave digital circuits. She joined the Jet Propulsion Laboratory, Pasadena, CA, USA, in 1998, where she is currently a Principal Engineer, involved in the design and testing of 30–600 GHz HEMT MMIC low-noise amplifiers and receivers, power amplifiers for local oscillator sources, and transmitters in future space missions.
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